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	Class	Subclass
ISSUE CLASSIFICATION		

**PATENT NUMBER**

U.S. **UTILITY** Patent Application

O.I.P.E.	PATENT DATE
SCANNED <i>Ed 2</i> Q.A. <i>Am</i>	

APPLICATION NO. 09/876290	CONT/PRIOR F	CLASS 438 251	SUBCLASS 686	ART UNIT 2812 (2814)	EXAMINER [Signature]
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## APPLICANTS

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**TITLE**

Assembly jig and manufacturing method of multilayer semiconductor device

PTO-2040  
12/99

ISSUING CLASSIFICATION												
ORIGINAL				CROSS REFERENCE(S)								
CLASS		SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)							
INTERNATIONAL CLASSIFICATION												

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<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>			<b>CLAIMS ALLOWED</b>	
	<b>Sheets Drwg.</b>	<b>Figs. Drwg.</b>	<b>Print Fig.</b>	<b>Total Claims</b>	<b>Print Claim for O.G.</b>
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.  <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	_____ (Assistant Examiner) (Date)  _____ (Primary Examiner) (Date)  _____ (Legal Instruments Examiner) (Date)			<b>NOTICE OF ALLOWANCE MAILED</b>	
				<b>ISSUE FEE</b>	
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